



Application Specific Discretes
A.S.D.TM

THBTxxx11D

TRIPOLAR OVERVOLTAGE
PROTECTION FOR TELECOM LINE

FEATURES

- BIDIRECTIONAL CROWBAR PROTECTION BETWEEN TIP AND GND, RING AND GND AND BETWEEN TIP AND RING.
- PEAK PULSE CURRENT : $I_{PP} = 30A$ for 10/1000 μs surge.
- HOLDING CURRENT : $I_H = 150mA$.
- AVAILABLE IN SO8 PACKAGES.
- LOW DYNAMIC BREAKOVER VOLTAGE.

DESCRIPTION

Dedicated to telecommunication equipment protection, these devices provide a triple bidirectional protection function.

They ensure the same protection capability with the same breakdown voltage both in longitudinal mode and transversal mode.

A particular attention has been given to the internal wire bonding. The "4-point" configuration ensures a reliable protection, eliminating overvoltages introduced by the parasitic inductances of the wiring (Ldi/dt), especially for very fast transient overvoltages.

Dynamic characteristics have been defined for several types of surges, in order to meet the SLIC maximum ratings.

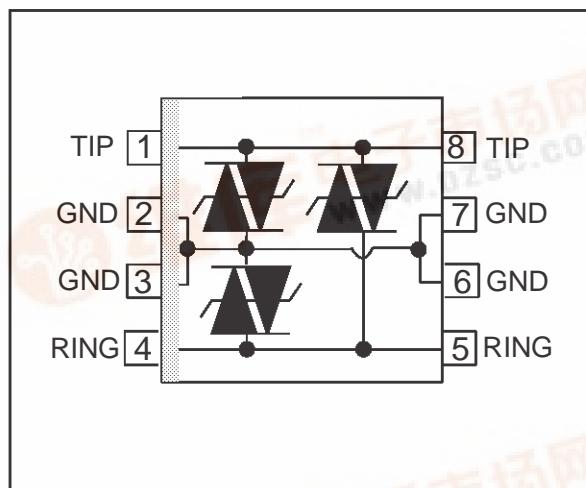
COMPLIES WITH THE FOLLOWING STANDARDS :

| | | |
|-----------------------------|-----------------|---------|
| CCITT K20 : | 10/700 μs | 1.5kV |
| | 5/310 μs | 20A (*) |
| VDE 0433 : | 10/700 μs | 2kV |
| | 5/310 μs | 20A (*) |
| VDE 0878 : | 1.2/50 μs | 1.5kV |
| | 1/20 μs | 20A (*) |
| CNET : | 0.5/700 μs | 1.5kV |
| | 0.2/310 μs | 20A (*) |
| FCC part 68 : | 2/10 μs | 2.5kV |
| | 2/10 μs | 40A (*) |
| BELLCORE TR-NWT-001089 : | 2/10 μs | 2.5kV |
| | 2/10 μs | 40A (*) |

(*) With series resistors or PTC.



SCHEMATIC DIAGRAM



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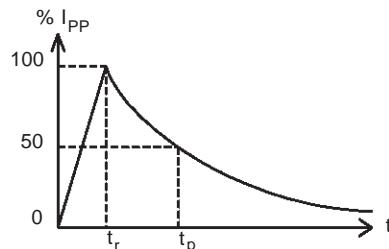
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ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25^{\circ}\text{C}$)

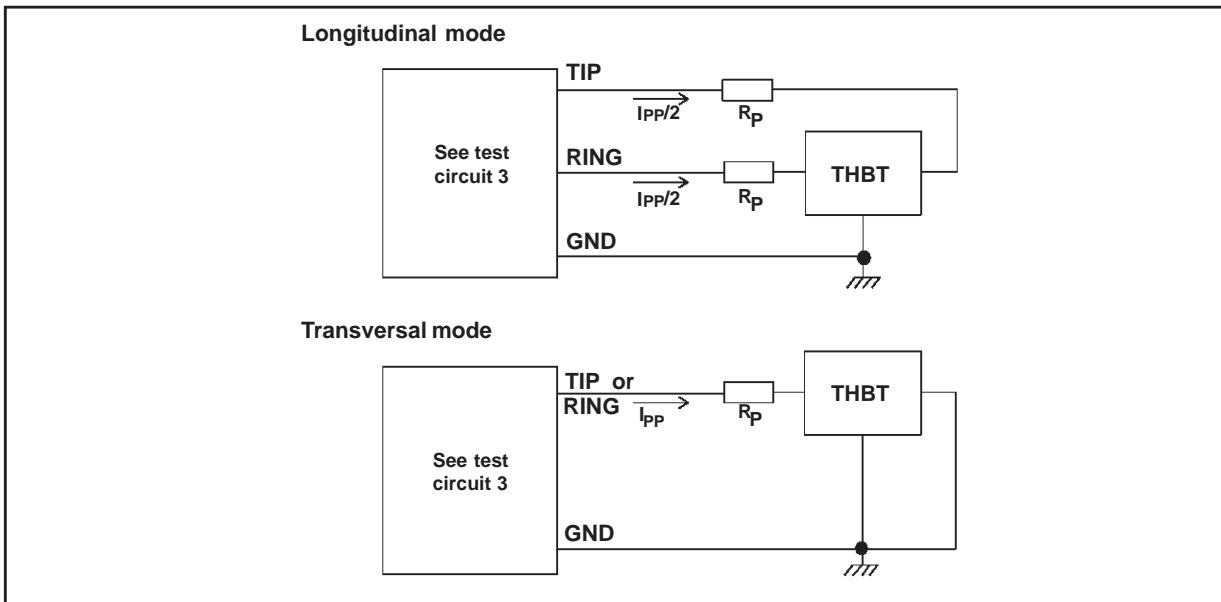
| Symbol | Parameter | Value | Unit | |
|--------------------|---|--|--|---|
| I_{PP} | Peak pulse current (see note 1) | 10/1000 μs | 30 | A |
| I_{TSM} | Non repetitive surge peak on-state current ($F=50\text{Hz}$) | $t_p = 10 \text{ ms}$ $t = 1\text{s}$ | 8 3.5 | A |
| T_{stg} T_j | Storage temperature range Maximum operating junction temperature | - 40 to + 150 + 150 | $^{\circ}\text{C}$ $^{\circ}\text{C}$ | |
| T_L | Maximum lead temperature for soldering during 10s | 260 | $^{\circ}\text{C}$ | |

Note 1 : Pulse waveform :

$$10/1000\mu\text{s} \quad t_r=10\mu\text{s} \quad t_p=1000\mu\text{s}$$



TEST CIRCUITS FOR I_{PP}

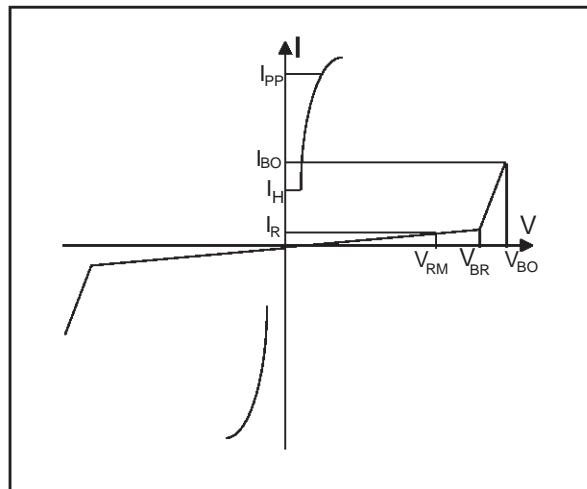


THERMAL RESISTANCES

| Symbol | Parameter | Value | Unit |
|---------------|---------------------|-------|----------------------|
| $R_{th(j-a)}$ | Junction to ambient | 170 | $^{\circ}\text{C/W}$ |

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25^\circ C$)

| Symbol | Parameter |
|----------|--------------------------------------|
| V_{RM} | Stand-off voltage |
| I_{RM} | Leakage current at stand-off voltage |
| V_R | Continuous Reverse voltage |
| V_{BR} | Breakdown voltage |
| V_{BO} | Breakover voltage |
| I_H | Holding current |
| I_{BO} | Breakover current |
| V_F | Forward voltage drop |
| I_{PP} | Peak pulse current |
| C | Capacitance |



STATIC PARAMETERS

| Type | $I_{RM} @ V_{RM}$ | | $I_R @ V_R$ | | $V_{BO} @ I_{BO}$ | | | I_H min note 3 | C max note 4 |
|------------|-------------------|-----|---------------------------|-----|-----------------------|--------------|--------------|------------------------|--------------------|
| | max. μA | V | max. note 1 μA | V | max. note 2 V | min. mA | max. mA | | |
| THBT15011D | 5 | 135 | 50 | 150 | 210 | 50 | 400 | 150 | 80 |
| THBT16011D | 5 | 135 | 50 | 160 | 230 | 50 | 400 | 150 | 80 |
| THBT20011D | 5 | 180 | 50 | 200 | 290 | 50 | 400 | 150 | 80 |
| THBT27011D | 5 | 240 | 50 | 270 | 380 | 50 | 400 | 150 | 80 |

Note 1: I_R measured at V_R guarantees $V_{BR} > V_R$

Note 2: Measured at 50Hz (1 cycle) test circuit 1.

Note 3: See the reference test circuit 2.

Note 4: $V_R = 1V$, $F = 1MHz$.

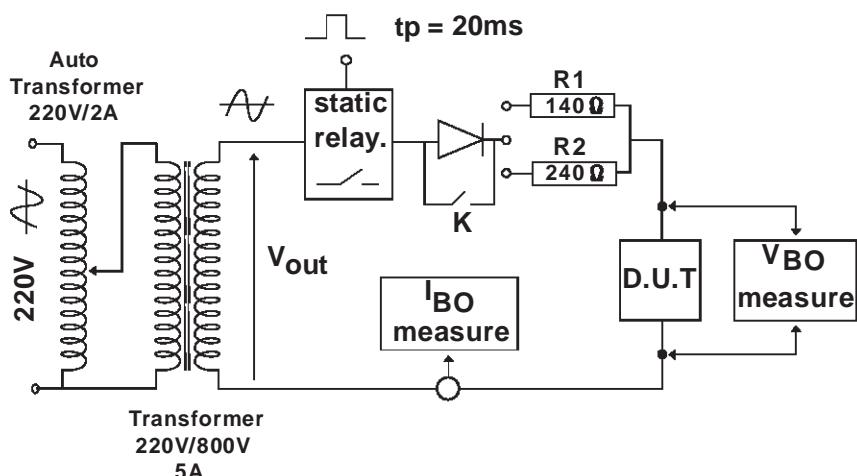
DYNAMIC BREAKOVER VOLTAGES (Transversal mode)

| Type | Symbol | Test conditions (see note 5) | | | | Maximum | Unit |
|------------|----------|------------------------------|-------|----------------|--------------|---------|------|
| THBT15011D | V_{BO} | 10/700μs | 1.5kV | $R_p=10\Omega$ | $I_{PP}=30A$ | 240 | V |
| | | 1.2/50μs | 1.5kV | $R_p=10\Omega$ | $I_{PP}=30A$ | 250 | |
| | | 2/10μs | 2.5kV | $R_p=62\Omega$ | $I_{PP}=38A$ | 260 | |
| THBT16011D | V_{BO} | 10/700μs | 1.5kV | $R_p=10\Omega$ | $I_{PP}=30A$ | 260 | V |
| | | 1.2/50μs | 1.5kV | $R_p=10\Omega$ | $I_{PP}=30A$ | 270 | |
| | | 2/10μs | 2.5kV | $R_p=62\Omega$ | $I_{PP}=38A$ | 290 | |
| THBT20011D | V_{BO} | 10/700μs | 1.5kV | $R_p=10\Omega$ | $I_{PP}=30A$ | 320 | V |
| | | 1.2/50μs | 1.5kV | $R_p=10\Omega$ | $I_{PP}=30A$ | 350 | |
| | | 2/10μs | 2.5kV | $R_p=62\Omega$ | $I_{PP}=38A$ | 400 | |
| THBT27011D | V_{BO} | 10/700μs | 1.5kV | $R_p=10\Omega$ | $I_{PP}=30A$ | 390 | V |
| | | 1.2/50μs | 1.5kV | $R_p=10\Omega$ | $I_{PP}=30A$ | 440 | |
| | | 2/10μs | 2.5kV | $R_p=62\Omega$ | $I_{PP}=38A$ | 480 | |

Note 5 : See test circuit 3 for V_{BO} dynamic parameters; R_p is the protection resistor located on the line card.

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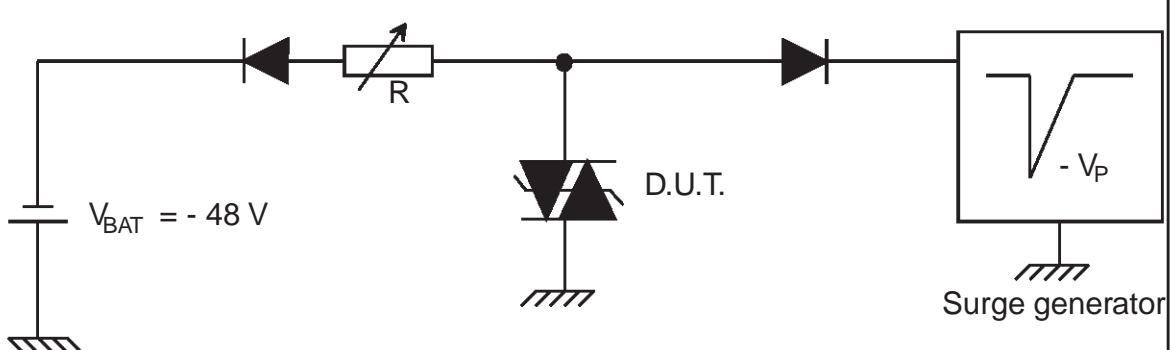
TEST CIRCUIT 1 for I_{BO} and V_{BO} parameters :



TEST PROCEDURE :

- Pulse Test duration ($tp = 20\text{ms}$):
 - For Bidirectional devices = Switch K is closed
 - For Unidirectional devices = Switch K is open.
- V_{out} Selection
 - Device with $V_{BO} < 200$ Volt
 - $V_{OUT} = 250 \text{ V}_{\text{RMS}}$, $R_1 = 140 \Omega$.
 - Device with $V_{BO} \geq 200$ Volt
 - $V_{OUT} = 480 \text{ V}_{\text{RMS}}$, $R_2 = 240 \Omega$.

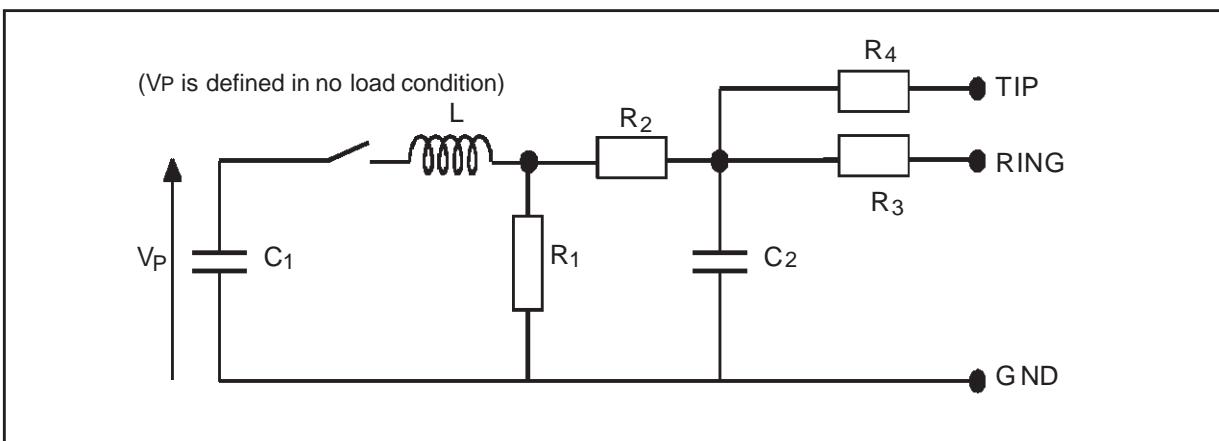
TEST CIRCUIT 2 for I_H parameter.



This is a GO-NOGO test which allows to confirm the holding current (I_H) level in a functional test circuit.

TEST PROCEDURE :

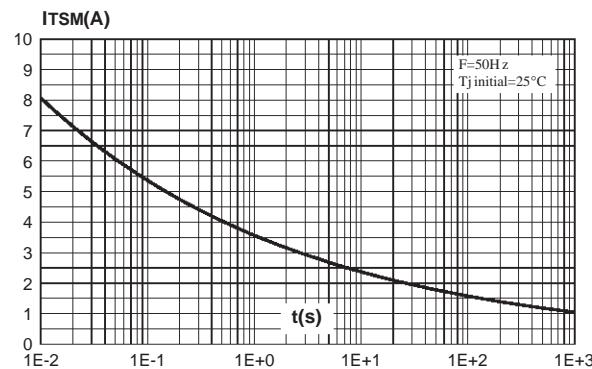
- 1) Adjust the current level at the I_H value by short circuiting the AK of the D.U.T.
- 2) Fire the D.U.T with a surge Current : $I_{PP} = 10\text{A}$, $10/1000 \mu\text{s}$.
- 3) The D.U.T will come back off-state within 50 ms max.

TEST CIRCUIT 3 for I_{PP} and V_{BO} parameters :

| Pulse (μs) | | V_p (V) | C_1 (μF) | C_2 (nF) | L (μH) | R_1 (Ω) | R_2 (Ω) | R_3 (Ω) | R_4 (Ω) | I_{PP} (A) | R_p (Ω) |
|-------------------|-------|--------------|----------------------|-------------------|--------------------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------|-----------------------|
| t_r | t_p | | | | | | | | | | |
| 10 | 700 | 1500 | 20 | 200 | 0 | 50 | 15 | 25 | 25 | 30 | 10 |
| 1.2 | 50 | 1500 | 1 | 33 | 0 | 76 | 13 | 25 | 25 | 30 | 10 |
| 2 | 10 | 2500 | 10 | 0 | 1.1 | 1.3 | 0 | 3 | 3 | 38 | 62 |

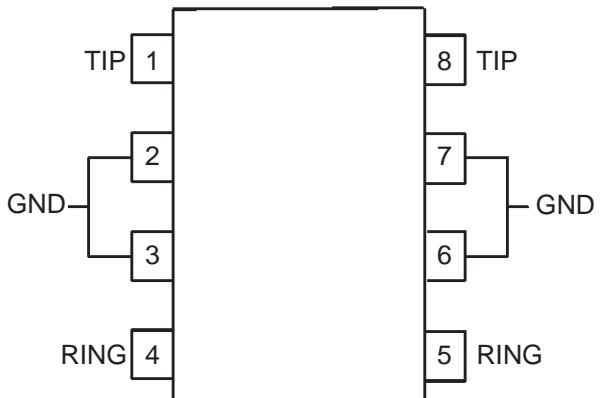
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Fig. 1: Surge peak current versus overload duration.



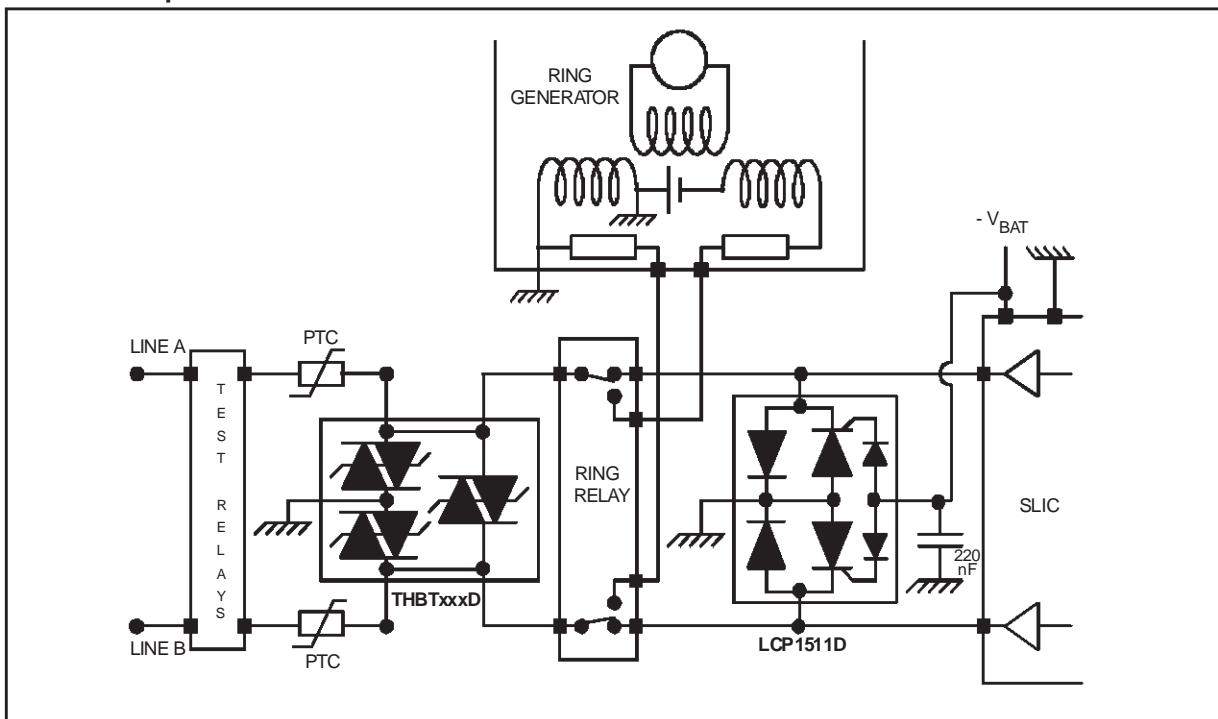
APPLICATION NOTE

- 1 Connect pins 2, 3, 6 and 7 to Ground in order to guarantee a good surge current capability for long duration disturbances.
- 2 In order to take advantage of the "4-point" structure of the THBT, the TIP and RING lines have to cross the device. In this case, the device will eliminate the overvoltages generated by the parasitic inductances of the wiring (Ldi/dt), especially for very fast transients.

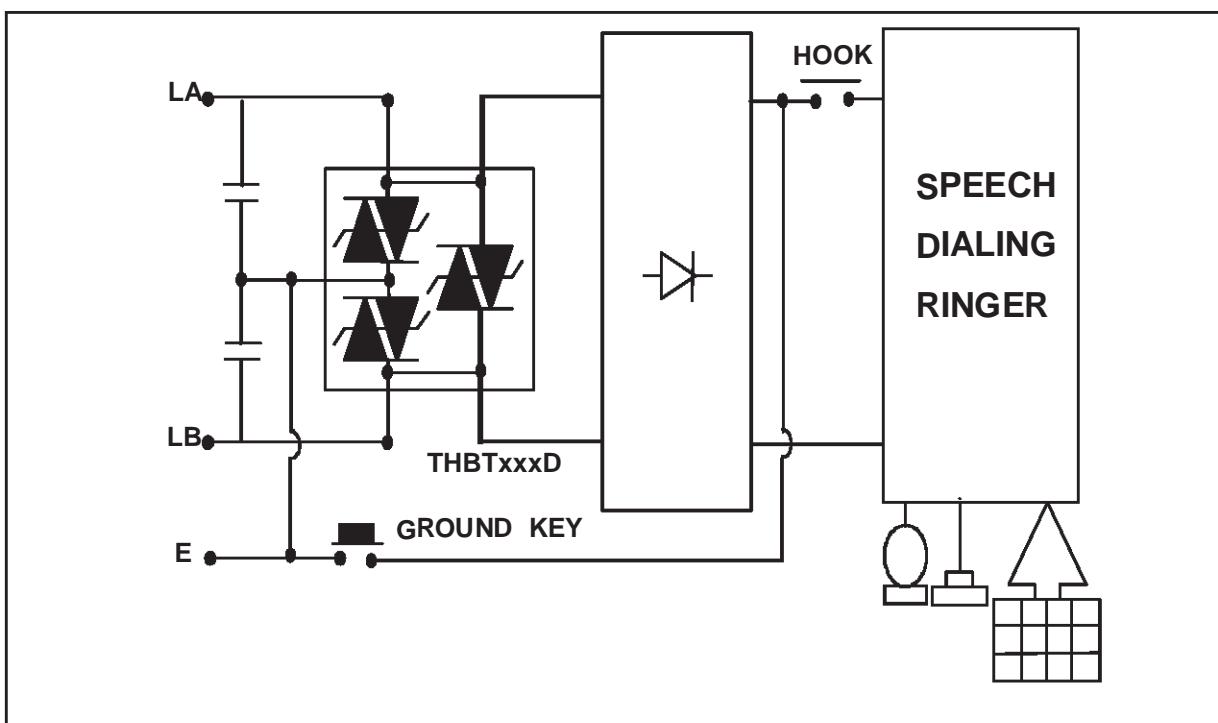


APPLICATION CIRCUIT :

1 - Line card protection

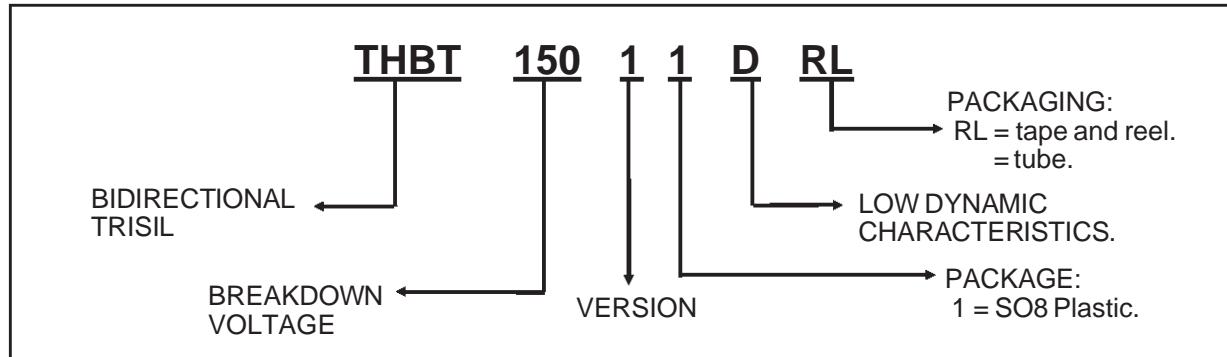


2 - Protection for telephone set with ground key



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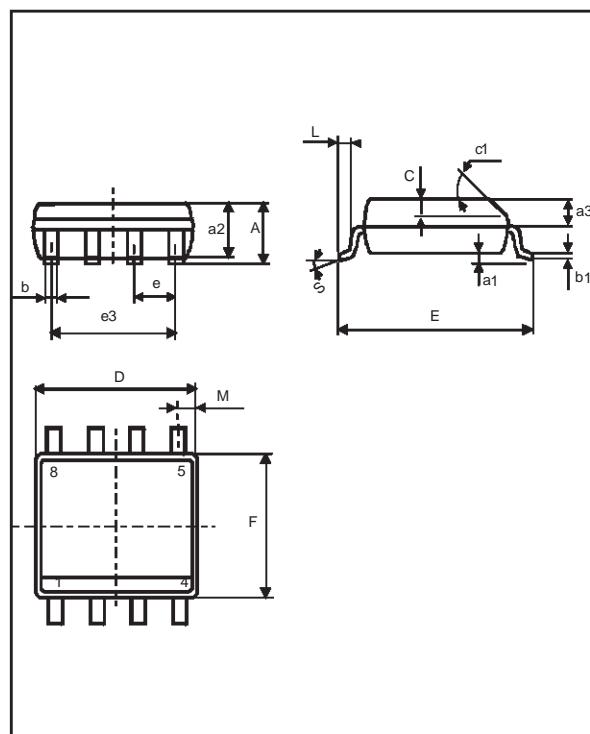
ORDER CODE



MARKING

| Types | Package | Marking |
|------------|---------|---------|
| THBT15011D | SO8 | BT151D |
| THBT16011D | SO8 | BT161D |
| THBT20011D | SO8 | BT201D |
| THBT27011D | SO8 | BT271D |

PACKAGE MECHANICAL DATA. SO8 Plastic



MARKING : Logo, Date Code, Part Number.

| REF. | DIMENSIONS | | | | | |
|------|-------------|------|------|--------|-------|-------|
| | Millimetres | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | | | 1.75 | | | 0.069 |
| a1 | 0.1 | | 0.25 | 0.004 | | 0.010 |
| a2 | | | 1.65 | | | 0.065 |
| b | 0.35 | | 0.48 | 0.014 | | 0.019 |
| b1 | 0.19 | | 0.25 | 0.007 | | 0.010 |
| C | | 0.50 | | | 0.020 | |
| c1 | 45° (typ) | | | | | |
| D | 4.8 | | 5.0 | 0.189 | | 0.197 |
| E | 5.8 | | 6.2 | 0.228 | | 0.244 |
| e | | 1.27 | | | 0.050 | |
| e3 | | 3.81 | | | 0.150 | |
| F | 3.8 | | 4.0 | 0.15 | | 0.157 |
| L | 0.4 | | 1.27 | 0.016 | | 0.050 |
| M | | | 0.6 | | | 0.024 |
| S | 8° (max) | | | | | |

Packaging : Products supplied in antistatic tubes or tape and reel.

Weight : 0.077g

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